

### **CLM3617**

## AC/DC Digital Power Controller for High Power Factor Dimmable LED Drivers 1 Description

The CLM3617 is a two-stage, high-performance AC/DC ofl ine power supply controller for dimmable LED luminaires. It applies advanced digital control technology to detect the dimmer type and phase, which provides dynamic impedance to interface the dimmer and control the LED brightness at the same time. The CLM3617 uses Dialog's unique digital *Flickerless*™ technology to eliminate visible I icker in the entire dimming range and minimize low frequency output ripple current.

With advanced dimmer detection technology, the CLM3617 can operate with most wall dimmers including leading-edge dimmers (R-type or R-L type) and trailing-edge dimmers (R-C type). In addition, the CLM3617's cycle-by-cycle waveform analysis technology allows fast dimmer setting response. When no dimmer is on the line, the CLM3617 optimizes the

power factor and minimizes the current harmonic distortion to the AC line.

The CLM3617 operates the main power converter that delivers constant current to the LED load in quasi-resonant mode to provide high power efi ciency and minimize electro-magnetic interference (EMI). It uses Dialog's patented **PrimAccurate<sup>TM</sup>** primary-side sensing technology to achieve excellent LED current regulation under different AC line and LED load voltages, without using a secondary-side feedback circuit and eliminating the need for an optocoupler.

The CLM3617 minimizes the external components count by simplifying the EMI i Iter with Dialog's *EZ-EMI*® technology. The intelligent dimmer detection technology eliminates the need for a high-power bleeder. Additionally, the digital control loop of the CLM3617 maintains stable overall operating conditions without the need for loop compensation components.

#### 2 Features

- Isolated/non-isolated offline 120V<sub>AC</sub>/230V<sub>AC</sub> LED driver up to 25W output power
- Wide line frequency ranges (from 45Hz to 66Hz)
- Meets IEC61000-3-2 requirement
- Total harmonic distortion < 15% with PF > 0.95
- Wide dimmer compatibility
  - » Leading-edge dimmer
  - » Trailing-edge dimmer
  - » Digital dimmer
  - » Occupancy sensors and timers
- Under 20% output ripple current
- Wide dimming range from 1% to 100%
- Flickerless™ LED dimming
- · Resonant control to achieve high efficiency

(typical > 85% without dimmer)

- Over-temperature LED current foldback
- Small solution size
  - » Two-stage topology enables small-size input and output filter capacitors
  - » 200kHz maximum switching frequency enables small transformer

- » Intelligent dimmer interface eliminates dedicated high-power bleeder
- PrimAccurate™ primary-side sensing eliminates the need for optocoupler feedback
- Tight LED current regulation (± 5%)
- Fast start-up (< 0.5s without dimmer)</li>
- Supports hot-plug LED module (Zhaga)
- Compatible with NEMA SSL6 dimming curve standard
- Supports wide LED output voltage range
- Multiple protection features:
  - » LED open-circuit and short-circuit protection
  - » Over-current and over-temperature protection
  - » Current sense resistor short-circuit protection
  - » AC line over-voltage/-frequency protection

### 3 Applications

- Dimmable LED retrofit lamps up to 25W
- Dimmable LED ballast and luminaires up to 25W



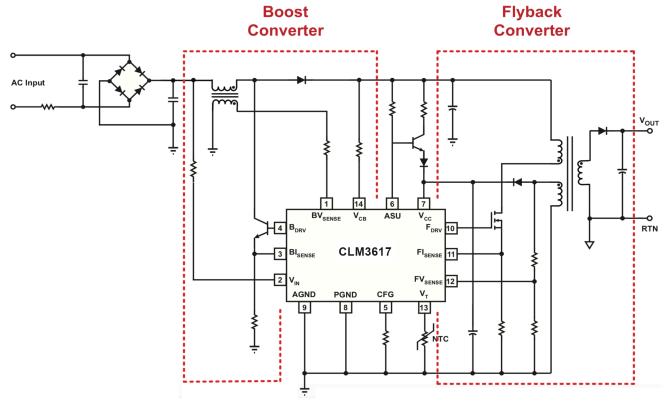


Figure 3.1 : CLM3617 Simplified Schematic



# **4 Pinout Description**

### **CLM3617**



Figure 4.1: 14-Lead SOIC Package

| Pin Number | Pin Name            | Туре          | Pin Description   |
|------------|---------------------|---------------|---|
| 1          | BV <sub>SENSE</sub> | Analog Input  | Boost inductor voltage feedback input   |
| 2          | V <sub>IN</sub>     | Analog Input  | Rectified AC line voltage input   |
| 3          | BI <sub>SENSE</sub> | Analog Input  | Boost current sense input   |
| 4          | B <sub>DRV</sub>    | Output        | Base drive output for boost BJT   |
| 5          | CFG                 | Analog In/Out | Driver parameter configuration pin and auxiliary driver   |
| 6          | ASU                 | Output        | Active start-up and bleeder control   |
| 7          | V <sub>cc</sub>     | Power         | Power supply for control logic and voltage sense for power-on reset circuit. A decoupling capacitor of 0.1µF or so should be connected between the Vcc pin and GND. |
| 8          | PGND                | Ground        | Power ground  |
| 9          | AGND                | Ground        | Signal ground. It should be connected to the power ground on PCB.   |
| 10         | F <sub>DRV</sub>    | Output        | Gate drive output for flyback MOSFET  |
| 11         | FI <sub>SENSE</sub> | Analog Input  | Flyback current sense (used for cycle-by-cycle peak current control and limit)  |
| 12         | FV <sub>SENSE</sub> | Analog Input  | Flyback voltage sense (used for primary-side regulation and ZVS)  |
| 13         | V <sub>T</sub>      | Analog Input  | External power limit shutdown control and external over-temperature power derating  |
| 14         | $V_{CB}$            | Analog Input  | Boost output voltage feedback input   |



# **5 Absolute Maximum Ratings**

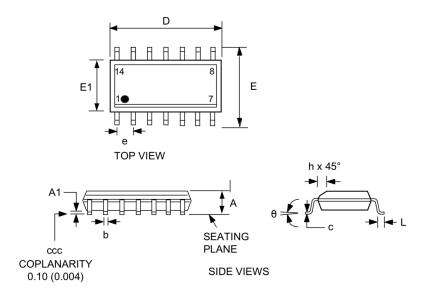
Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded. For maximum safe operating conditions, refer to Electrical Characteristics in Section 6.

| Parameter  | Symbol            | Value       | Units |
|--|-------------------|-------------|-------|
| DC supply voltage range (pin 7)                              | V <sub>cc</sub>   | -0.3 to 18  | V     |
| FDRV output (pin 10)   |                   | -0.3 to 18  | V     |
| BDRV output (pin 4)  |                   | -0.3 to 4.0 | V     |
| CFG input (pin 5)  |                   | -0.3 to 4.0 | V     |
| CFG output (pin 5)   |                   | -0.3 to 18  | V     |
| FV <sub>SENSE</sub> input (pin 12, I ≤ 10mA)                 |                   | -0.7 to 4.0 | V     |
| BV <sub>SENSE</sub> input (pin 1, I ≤ 3mA)                   |                   | -0.7 to 4.0 | V     |
| V <sub>IN</sub> input (pin 2)                                |                   | -0.3 to 18  | V     |
| V <sub>CB</sub> input (pin 14)                               |                   | -0.3 to 18  | V     |
| FISENSE input (pin 11)                                       |                   | -0.3 to 4.0 | V     |
| BISENSE input (pin 3)  |                   | -0.3 to 4.0 | V     |
| ASU output (pin 6)   |                   | -0.3 to 18  | V     |
| V⊤ input (pin 13)  |                   | -0.3 to 4.0 | V     |
| Maximum junction temperature                                 | T <sub>JMAX</sub> | 150         | °C    |
| Operating junction temperature                               | T <sub>JOPT</sub> | -40 to 150  | °C    |
| Storage temperature  | T <sub>STG</sub>  | -65 to 150  | °C    |
| Thermal Resistance Junction-to-PCB Board Surface Temperature | $\Psi_{JB}$       | 45          | °C/W  |
| ESD rating per JEDEC JESD22-A114                             |                   | ±2,000      | V     |
| Latch-up test per JESD78A                                    |                   | ±100        | mA    |



## **6 Physical Dimensions**

#### 14-Lead SOIC Package



| Symbol | Incl  | hes   | Millimeters |      |  |
|--------|-------|-------|-------------|------|--|
| Syr    | MIN   | MAX   | MIN         | MAX  |  |
| Α      | 0.053 | 0.069 | 1.35        | 1.75 |  |
| A1     | 0.004 | 0.010 | 0.10        | 0.25 |  |
| b      | 0.013 | 0.020 | 0.33        | 0.51 |  |
| С      | 0.007 | 0.010 | 0.19        | 0.25 |  |
| D      | 0.337 | 0.344 | 8.55        | 8.75 |  |
| E1     | 0.150 | 0.157 | 3.80        | 4.00 |  |
| Е      | 0.228 | 0.244 | 5.80        | 6.20 |  |
| е      | 0.050 | BSC   | 1.27 BSC    |      |  |
| Г      | 0.016 | 0.050 | 0.40        | 1.27 |  |
| h      | 0.010 | 0.020 | 0.25        | 0.50 |  |
| θ      | 0°    | 8°    | 0°          | 8°   |  |
| ССС    | 0.0   | 04    | 0.10        |      |  |

Compliant to JEDEC Standard MS12F

Controlling dimensions are in inches; millimeter dimensions are for reference only

This product is RoHS compliant and Halide free.

Soldering Temperature Resistance:

[a] Package is IPC/JEDEC Std 020D Moisture Sensitivity Level 1
[b] Package exceeds JEDEC Std No. 22-A111 for Solder Immersion Resistance; package can withstand 10 s immersion < 260°C

Dimension D does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per end. Dimension E does not include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25 mm per side.

The package top may be smaller than the package bottom. Dimensions D and E are determined at the outermost extremes of the plastic body exclusive of mold flash, tie bar burrs, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

Figure 6.1: 14-Lead SOIC Package

## 7 Ordering Information

| Part no.   | Options                  | Package | Description              |
|------------|--------------------------|---------|--------------------------|
| CLM3617-00 | 120V <sub>AC</sub> Input | SOIC-14 | Tape & Reel <sup>1</sup> |
| CLM3617-01 | 230V <sub>AC</sub> Input | SOIC-14 | Tape & Reel <sup>1</sup> |

Note 1: Tape & Reel packing quantity is 2,500/reel. Minimum ordering quantity is 2,500.